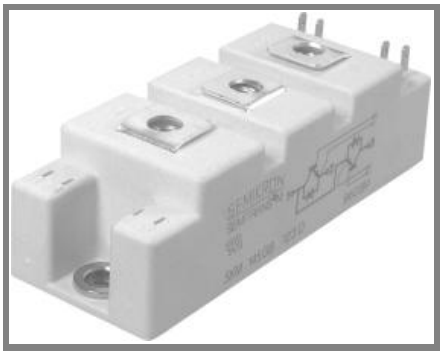
SKM 75GB123D



SEMITRANS® 2

IGBT Modules

SKM 75GB123D

SKM 75GAL123D

SKM 75GAR123D

Features

- MOS input (voltage controlled)
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- Large clearance (10 mm) and creepage distance (20 mm)

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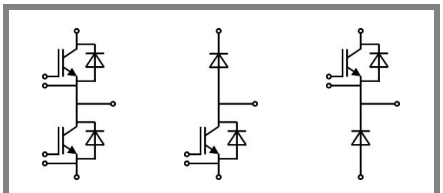
- AC inverter drives
- UPS

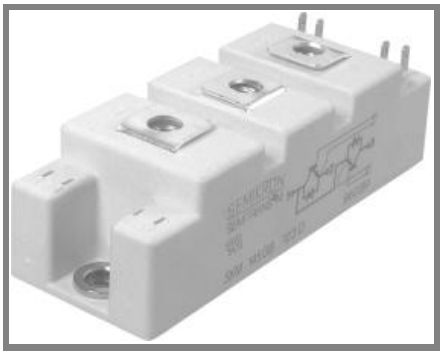


GB GAL GAR

Absolute Maximum Ratings			T_c = 25 °C, unless otherwise specified	
Symbol	**Conditions**		**Values**	**Units**
IGBT				
V_{CES}	T_j = 25 °C		1200	V
I_C	T_j = 150 °C	T_{case} = 25 °C	75	A
		T_{case} = 80 °C	60	A
I_{CRM}	I_{CRM}=2xI_{Cnom}		150	A
V_{GES}			± 20	V
t_{psc}	V_{CC} = 600 V; $V_{GE} \leq$ 20 V; V_{CES} < 1200 V	T_j = 125 °C	10	µs
Inverse Diode				
I_F	T_j = 150 °C	T_{case} = 25 °C	75	A
		T_{case} = 80 °C	50	A
I_{FRM}	I_{FRM}=2xI_{Fnom}		150	A
I_{FSM}	t_p = 10 ms; sin.	T_j = 150 °C	480	A
Freewheeling Diode				
I_F	T_j = 150 °C	T_{case} = 25 °C	95	A
		T_{case} = 80 °C	65	A
I_{FRM}	I_{FRM}=2xI_{Fnom}		200	A
I_{FSM}	t_p = 10 ms; sin	T_j = 150 °C	720	A
Module				
$I_{t(RMS)}$			200	A
T_{vj}			- 40 ...+ 150	°C
T_{stg}			- 40 ...+ 125	°C
V_{isol}	AC, 1 min.		2500	V

Characteristics			T_c = 25 °C, unless otherwise specified			
Symbol	**Conditions**		**min.**	**typ.**	**max.**	**Units**
IGBT						
$V_{GE(th)}$	V_{GE} = V_{CE}, I_C = 2 mA		4,5	5,5	6,5	V
I_{CES}	V_{GE} = 0 V, V_{CE} = V_{CES}	T_j = 25 °C		0,1	0,3	mA
V_{CE0}		T_j = 25 °C		1,4	1,6	V
		T_j = 125 °C		1,6	1,8	V
r_{CE}	V_{GE} = 15 V	T_j = 25°C		22	28	mΩ
		T_j = 125°C		30	38	mΩ
$V_{CE(sat)}$	I_{Cnom} = 50 A, V_{GE} = 15 V	T_j = °$C_{chiplev.}$		2,5	3	V
C_{ies}	V_{CE} = 25, V_{GE} = 0 V	f = 1 MHz		3,3	4,3	nF
C_{oes}				0,5	0,6	nF
C_{res}				0,22	0,3	nF
Q_G	V_{GE} = -8 - +20V			500		nC
R_{Gint}	T_j = °C			5		Ω
$t_{d(on)}$	R_{Gon} = 22 Ω	V_{CC} = 600V		44	100	ns
t_r		I_C= 50A		56	100	ns
E_{on}		T_j = 125 °C		8		mJ
$t_{d(off)}$	R_{Goff} = 22 Ω	V_{GE} = ±15V		380	500	ns
t_f				70	100	ns
E_{off}				5		mJ
$R_{th(j-c)}$	per IGBT				0,27	K/W

SKM 75GB123D



SEMITRANS® 2

IGBT Modules

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SKM 75GAL123D

SKM 75GAR123D

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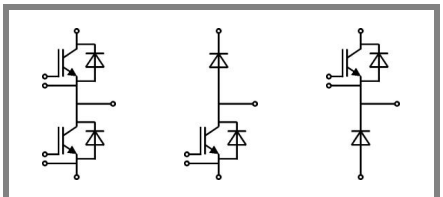


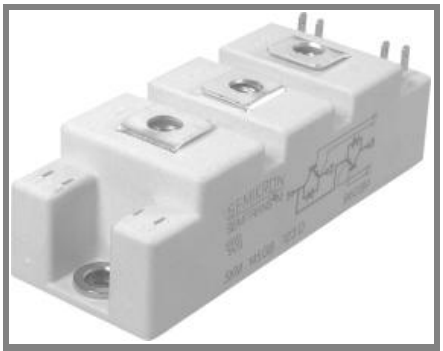
GB **GAL** **GAR**

Characteristics						
Symbol	**Conditions**		**min.**	**typ.**	**max.**	**Units**
Inverse Diode						
$V_F = V_{EC}$	I_{Fnom} = 50 A; V_{GE} = 0 V	T_j = 25 °$C_{chiplev.}$		2	2,5	V
		T_j = 125 °$C_{chiplev.}$		1,8		V
V_{F0}		T_j = 25 °C		1,1	1,2	V
		T_j = 125 °C				V
r_F		T_j = 25 °C		18	26	mΩ
		T_j = 125 °C				mΩ
I_{RRM}	I_F = 50 A	T_j = 125 °C		35		A
Q_{rr}	di/dt = 800 A/µs					µC
E_{rr}	V_{GE} = 0 V; V_{CC} = 600 V					mJ
$R_{th(j-c)D}$	per diode				0,6	K/W
Freewheeling Diode						
$V_F = V_{EC}$	I_{Fnom} = 50 A; V_{GE} = 0 V	T_j = 25 °$C_{chiplev.}$		1,85	2,2	V
		T_j = 125 °$C_{chiplev.}$		1,6		V
V_{F0}		T_j = 25 °C		1,1	1,2	V
		T_j = 125 °C				V
r_F		T_j = 25 °C		15	20	V
		T_j = 125 °C				V
I_{RRM}	I_F = 50 A	T_j = 125 °C		40		A
Q_{rr}						µC
E_{rr}	V_{GE} = 0 V; V_{CC} = 600 V					mJ
$R_{th(j-c)FD}$	per diode				0,5	K/W
Module						
L_{CE}					30	nH
$R_{CC'+EE'}$	res., terminal-chip	T_{case}= 25 °C		0,75		mΩ
		T_{case}= 125 °C		1		mΩ
$R_{th(c-s)}$	per module				0,05	K/W
M_s	to heat sink M6		3		5	Nm
M_t	to terminals M5		2,5		5	Nm
w					160	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.

SKM 75GB123D



SEMITRANS® 2

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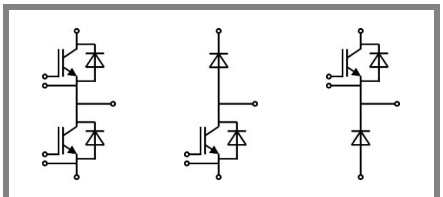


GB **GAL** **GAR**

Z_{th} Symbol	Conditions	Values	Units
$Z_{th(j-c)I}$			
R_i	i = 1	180	mk/W
R_i	i = 2	64	mk/W
R_i	i = 3	22	mk/W
R_i	i = 4	4	mk/W
tau_i	i = 1	0,0327	s
tau_i	i = 2	0,0479	s
tau_i	i = 3	0,008	s
tau_i	i = 4	0,005	s
$Z_{th(j-c)D}$			
R_i	i = 1	380	mk/W
R_i	i = 2	190	mk/W
R_i	i = 3	26	mk/W
R_i	i = 4	4	mk/W
tau_i	i = 1	0,0947	s
tau_i	i = 2	0,006	s
tau_i	i = 3	0,08	s
tau_i	i = 4	0,003	s

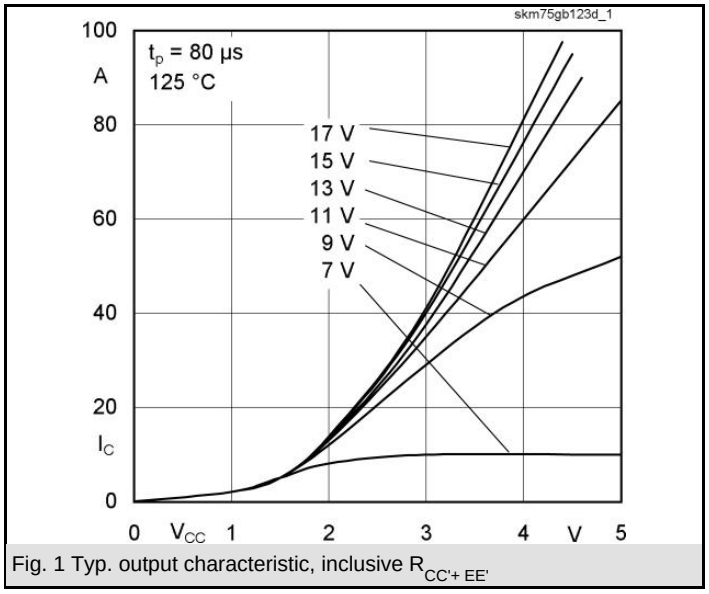


Fig. 1 Typ. output characteristic, inclusive $R_{CC'+ EE'}$

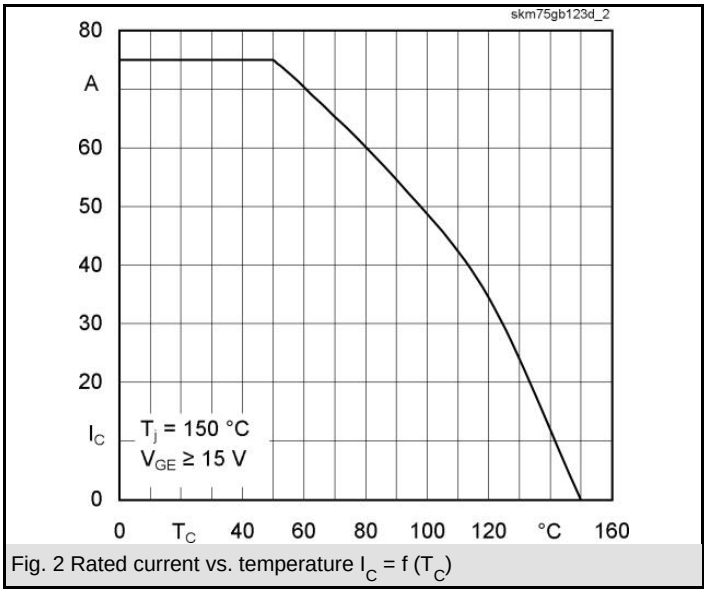


Fig. 2 Rated current vs. temperature $I_C = f(T_C)$

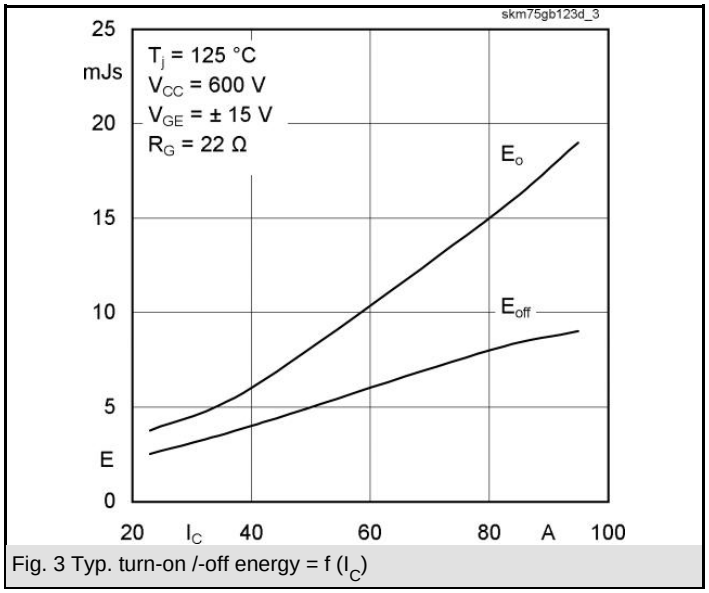


Fig. 3 Typ. turn-on /-off energy = f (I_C)

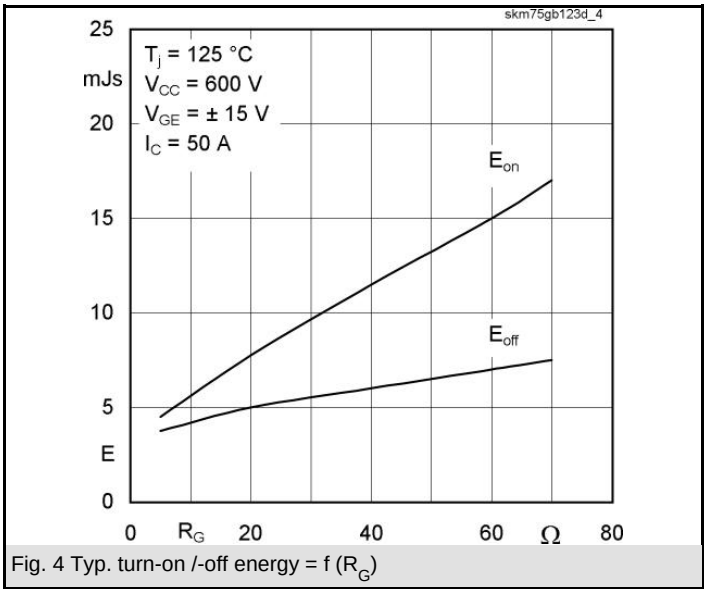


Fig. 4 Typ. turn-on /-off energy = f (R_G)

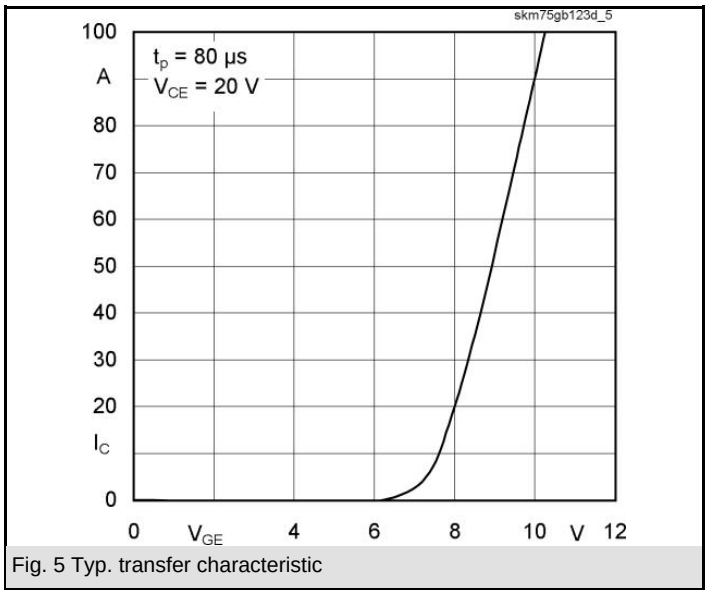


Fig. 5 Typ. transfer characteristic

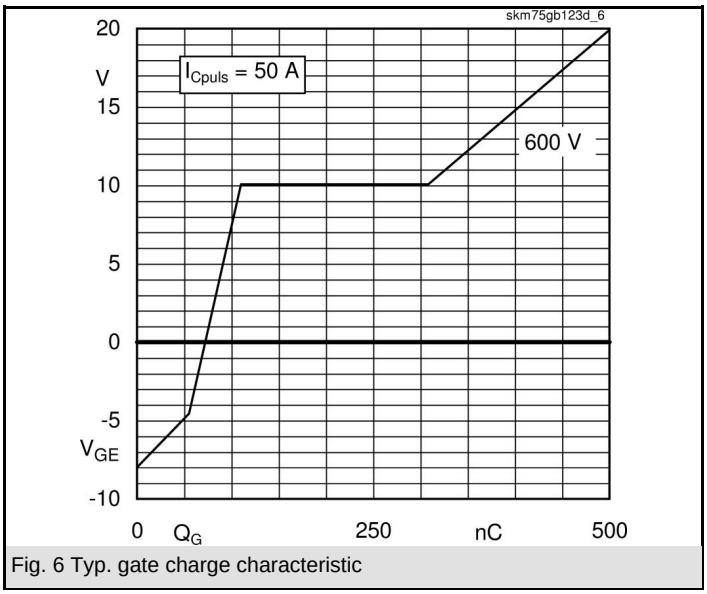


Fig. 6 Typ. gate charge characteristic

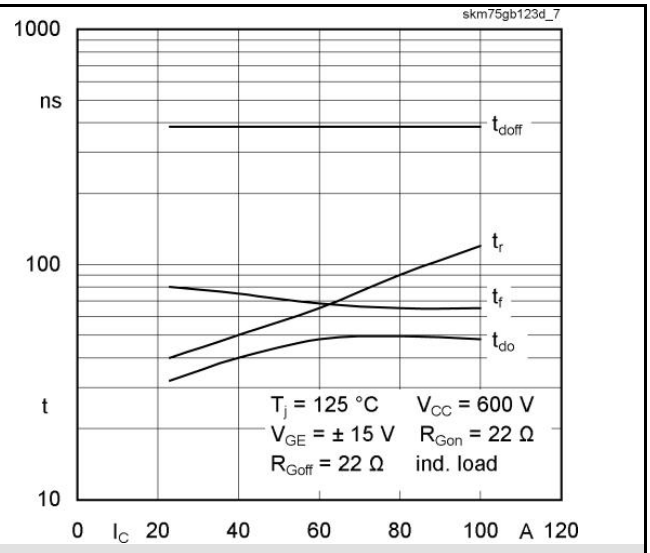


Fig. 7 Typ. switching times vs. I_C

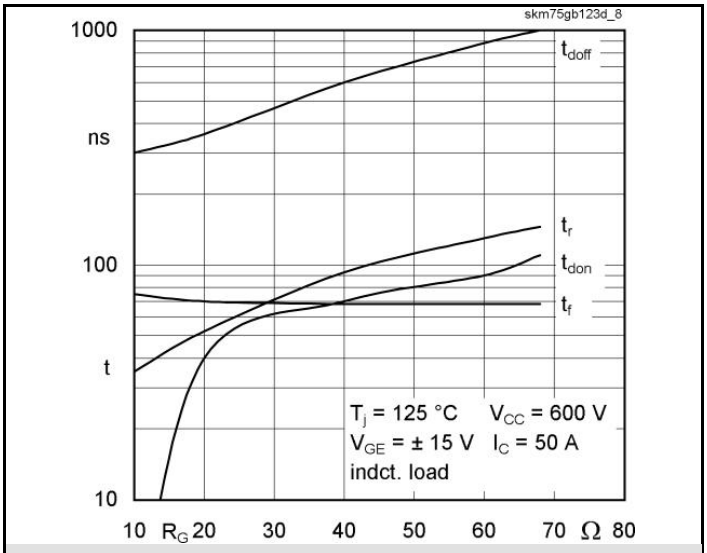


Fig. 8 Typ. switching times vs. gate resistor R_G

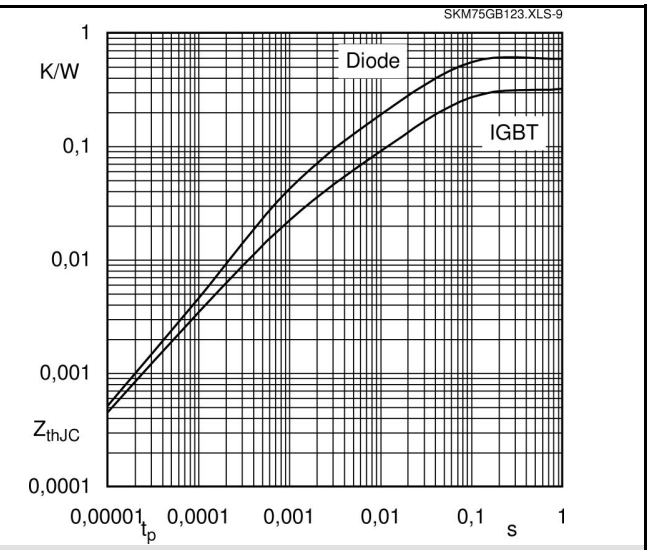


Fig. 9 Typ. transient thermal impedance

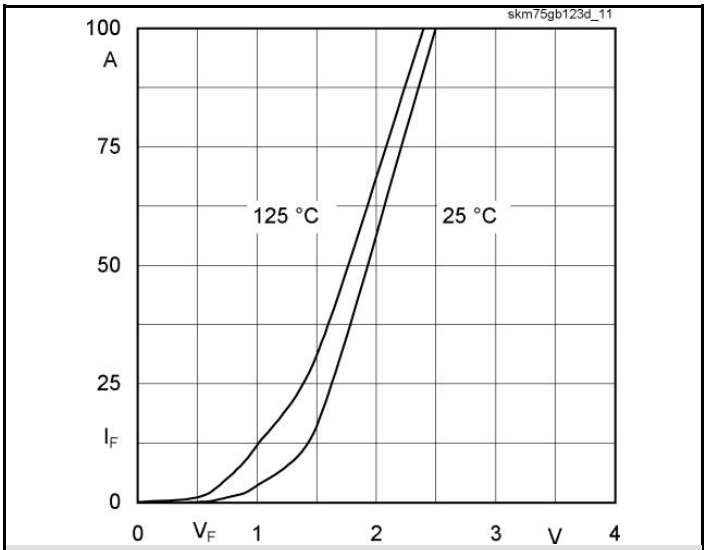


Fig. 10 CAL diode forward characteristic

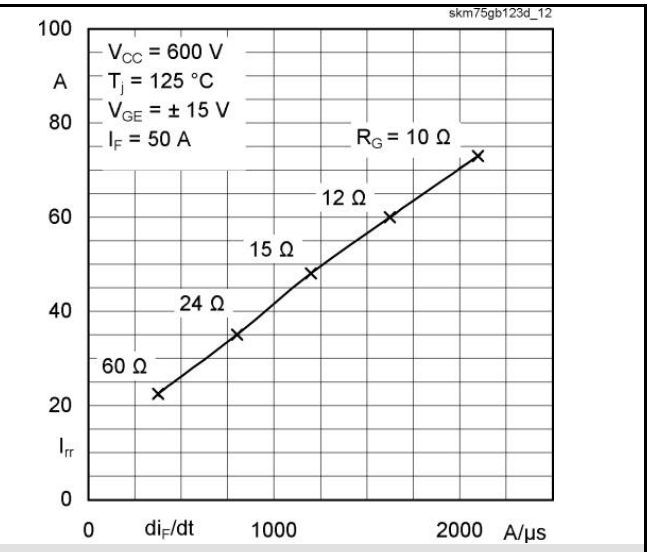


Fig. 11 Typ. CAL diode peak reverse recovery current

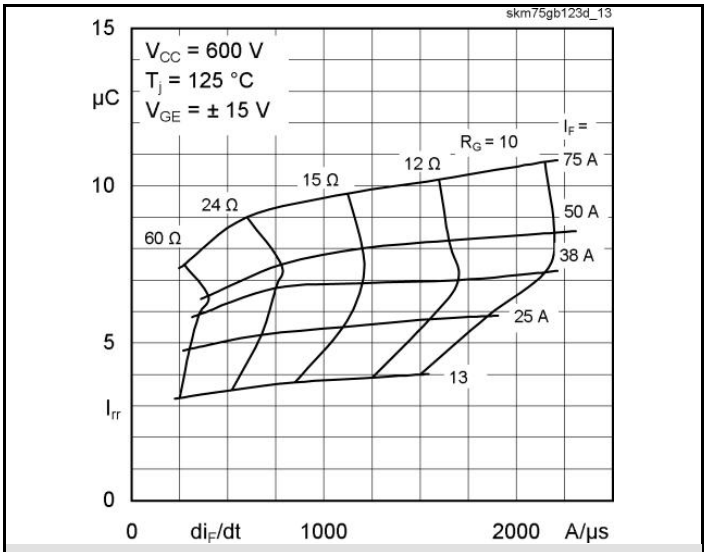
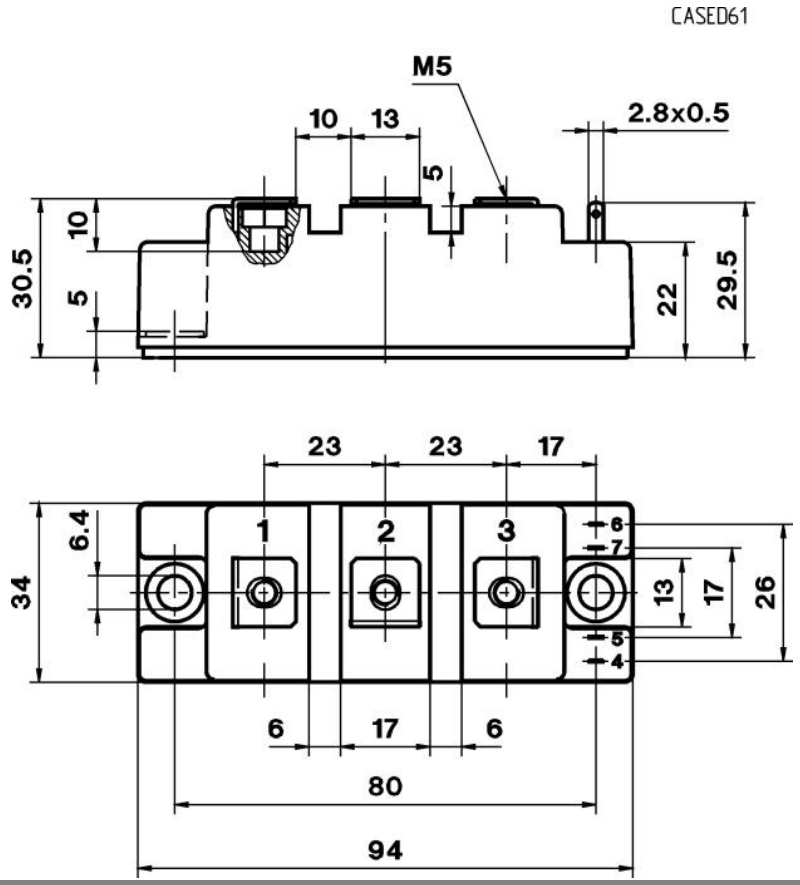
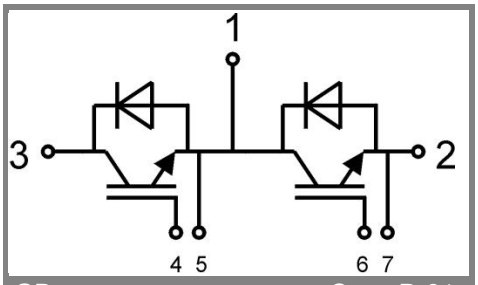


Fig. 12 Typ. CAL diode reverse recovery charge

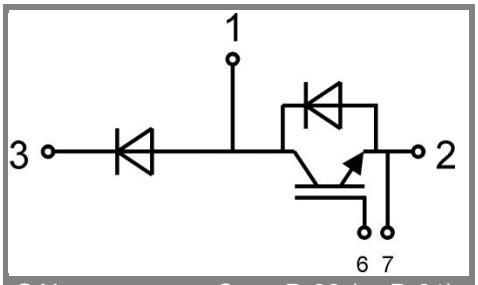
UL Recognized File 63 532



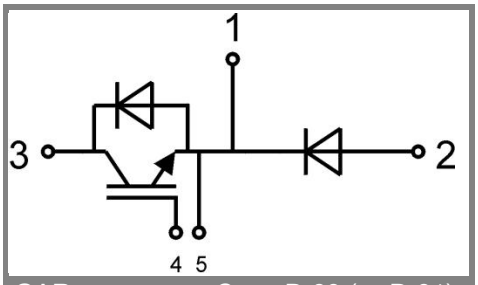
Case D 61



GB Case D 61



GAL Case D 62 (➞ D 61)



GAR Case D 63 (➞ D 61)

